





#### 70V PNP LOW SATURATION TRANSISTOR

#### **Features and Benefits**

- BV<sub>CEO</sub> > -70V
- I<sub>C</sub> = -2.5A Continuous Collector Current
- Low Saturation Voltage (-220mV max @ -1A)
- R<sub>SAT</sub> = 117 mΩ for a low equivalent On-Resistance
- hFE specified up to -3A for high current gain hold up
- Low profile 0.6mm high package for thin applications
- R<sub>BJA</sub> efficient, 60% lower than SOT23
- 4mm<sup>2</sup> footprint, 50% smaller than SOT23
- Lead-Free, RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

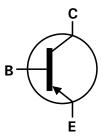
#### **Mechanical Data**

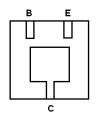
- Case: DFN2020B-3
- Case material: Molded Plastic. "Green" Molding Compound.
- Terminals: Pre-Plated NiPdAu leadframe.
- Nominal package height: 0.6mm
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Weight: 0.01 grams (approximate)

### **Applications**

- MOSFET Gate Driving
- DC-DC Converters
- Charging Circuits
- Power switches
- Motor control







Device Symbol

Bottom View Pin-Out

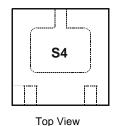
## **Ordering Information**

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTP722MATA	S4	7	8	3000

Notes:

- 1. No purposefully added lead.
- 2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com

## **Marking Information**



S4 = Product Type Marking code





### Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit	
Collector-Base Voltage		V <sub>CBO</sub>	-70		
Collector-Emitter Voltage		V <sub>CEO</sub>	-70	V	
Emitter-Base Voltage		V <sub>EBO</sub>	-7		
Peak Pulse Current		I <sub>CM</sub>	-3		
Continuous Collector Current	(Note 3)	1	-2.5	1 ,	
	(Note 4)	Ic	-2.7	] ^	
Base Current		I <sub>B</sub>	-1		

# Thermal Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit		
Power Dissipation	(Note 3)		1.5 12	W	
Linear Derating Factor	(Note 4)	P <sub>D</sub>	2.45 19.6	mW/°C	
Thermal Desistance Junction to Ambient	(Note 3)		83		
Thermal Resistance, Junction to Ambient	(Note 4)	R <sub>θ</sub> JA	51	°C/W	
Thermal Resistance, Junction to Lead	(Note 5)	$R_{ heta JL}$	16.8		
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

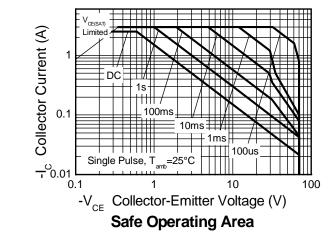
- 3. For a device surface mounted on 31mm x 31mm (10cm<sup>2</sup>) FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition. The entire exposed collector pad is attached to the heatsink.
- 4. Same as note (3), except the device is measured at t ≤ 5 sec.

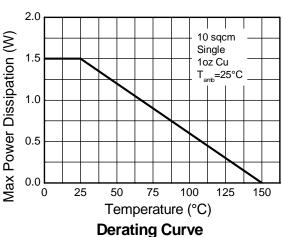
  5. For a single device, thermal resistance from junction to solder-point (at the end of the drain lead).

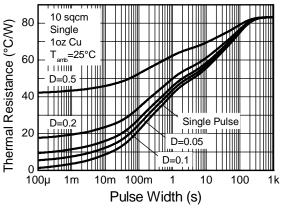


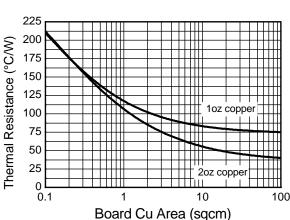


### **Thermal Characteristics**



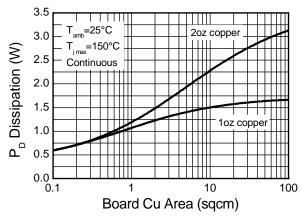






### **Transient Thermal Impedance**

Thermal Resistance v Board Area



**Power Dissipation v Board Area** 





## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

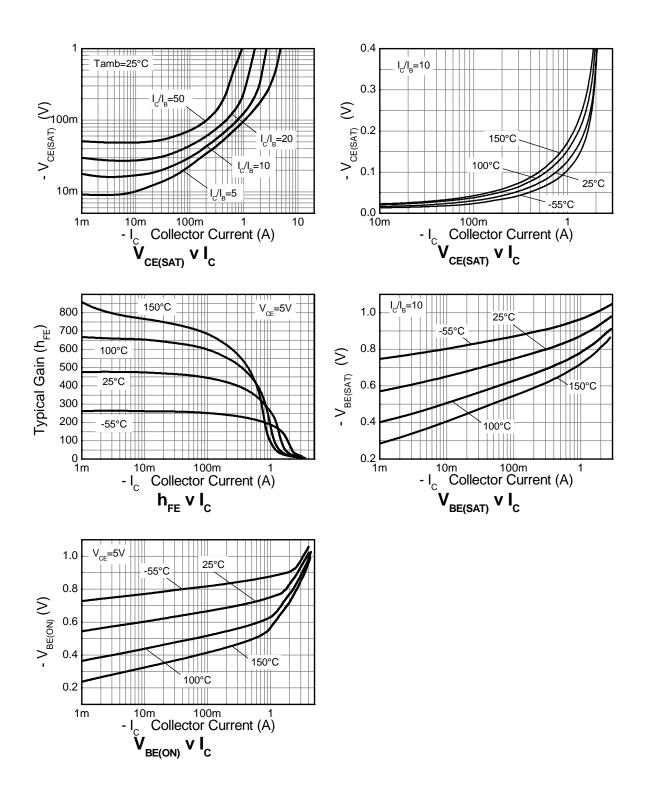
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-70	-150	-	V	$I_C = -100 \mu A$
Collector-Emitter Breakdown Voltage (Note 6)	BV <sub>CEO</sub>	-70	-125	-	V	I <sub>C</sub> = -10mA
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	-7	-8.5	-	V	$I_E = -100 \mu A$
Collector Cutoff Current	I <sub>CBO</sub>	-	-	-100	nA	$V_{CB} = -55V$
Emitter Cutoff Current	I <sub>EBO</sub>	-	-	-100	. nA	$V_{EB} = -6V$
Collector Emitter Cutoff Current	I <sub>CES</sub>	-	-	-100	nA	V <sub>CES</sub> = -55V
Static Forward Current Transfer Ratio (Note 6)	h <sub>FE</sub>	300 300 175 40	470 450 275 60 10		-	$\begin{split} I_C &= -10 \text{mA}, \ V_{CE} = -5 \text{V} \\ I_C &= -100 \text{mA}, \ V_{CE} = -5 \text{V} \\ I_C &= -1A, \ V_{CE} = -5 \text{V} \\ I_C &= -1.5 \text{A}, \ V_{CE} = -5 \text{V} \\ I_C &= -3 \text{A}, \ V_{CE} = -5 \text{V} \end{split}$
Collector-Emitter Saturation Voltage (Note 6)	V <sub>CE(sat)</sub>	- - -	-35 -135 -140 -175	-50 -200 -220 -270	mV	$I_C = -0.1A$ , $I_B = -10mA$ $I_C = -0.5A$ , $I_B = -20mA$ $I_C = -1A$ , $I_B = -100mA$ $I_C = -1.5A$ , $I_B = -200mA$
Base-Emitter Turn-On Voltage (Note 6)	$V_{BE(on)}$	-	-0.78	-1.00	V	$I_C = -1.5A$ , $V_{CE} = -5V$
Base-Emitter Saturation Voltage (Note 6)	V <sub>BE(sat)</sub>	-	-0.94	-1.05	V	$I_C = -1.5A$ , $I_B = -200mA$
Output Capacitance	$C_obo$	-	14	20	pF	$V_{CB} = -10V$ . $f = 1MHz$
Transition Frequency	f <sub>T</sub>	150	180	-	MHz	$V_{CE} = -10V, I_{C} = -50mA,$ f = 100MHz
Turn-On Time	t <sub>on</sub>	-	40	-	ns	$V_{CC} = -50V, I_{C} = -1A$
Turn-Off Time	t <sub>off</sub>	-	700	-	ns	$I_{B1} = I_{B2} = -50 \text{mA}$

Notes: 6. Measured under pulsed conditions. Pulse width  $\leq$  300  $\mu$ s. Duty cycle  $\leq$  2%.





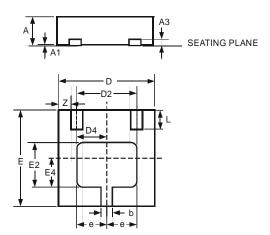
## **Typical Electrical Characteristics**





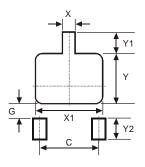


# Package Outline Dimensions



DFN2020B-3					
Dim	Min	Max	Тур		
Α	0.57	0.63	0.60		
A1	0	0.05	0.02		
A3	_	_	0.152		
b	0.20	0.30	0.25		
D	1.95	2.075	2.00		
D2	1.22	1.42	1.32		
D4	0.56	0.76	0.66		
е	_	_	0.65		
Е	1.95	2.075	2.00		
E2	0.79	0.99	0.89		
E4	0.48	0.68	0.58		
L	0.25	0.35	0.30		
Z		_	0.225		
All Dimensions in mm					

# Suggested Pad Layout



Dimensions	Value (in mm)
С	1.30
G	0.24
Х	0.35
X1	1.52
Y	1.09
Y1	0.47
Y2	0.50





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